ABSOLUTE MAXIMUM RATINGS

Parameter		Limit	Unit
Voltages Referenced to - V_{IN} (V_{CC} < + V_{IN} + 0.3 V)			
V_{CC}		15	V
$+V_{IN}$		120	
V_{DS}		200	
I_D (Peak) (Note: 300 µs pulse, 2 % Duty Cycle)		2	A
I_D (rms)		250	mA
Logic Inputs (RESET, $\overline{\text{SHUTDOWN}}$, OSC IN)		- 0.3 to V_{CC} + 0.3	V
Linear Inputs (FEEDBACK, SOURCE)		- 0.3 to 7	
HV Pre-Regulator Input Current (continuous)		3	mA
Storage Temperature		- 65 to 125	°C
Operating Temperature		- 40 to 85	
Junction Temperature (T_J)		150	
Power Dissipation (Package)[a]	16-Pin Plastic Wide-Body SOIC[b]	900	mW
Thermal Impedance (Θ_{JA})	16-Pin Plastic Wide-Body SOIC	140	°C/W

Notes:

a. Device Mounted with all leads soldered or welded to PC board.

b. Derate 7.2 mW/°C above 25 °C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE

Parameter	Limit	Unit
Voltages Referenced to - V_{IN}		
V_{CC}	10 to 13.5	V
+ V_{IN}	10 to 120	
f_{OSC}	40 kHz to 1 MHz	
R_{OSC}	25 kΩ to 1 MΩ	
Linear Inputs	0 to 7	V
Digital Inputs	0 to V_{CC}	

SPECIFICATIONS[a]

Parameter	Symbol	Test Conditions Unless Otherwise Specified DISCHARGE = - V_{IN} = 0 V, V_{CC} = 10 V, + V_{IN} = 48 V, R_{BIAS} = 390 kΩ, R_{OSC} = 330 kΩ	Limits D Suffix - 40 to 85 °C Temp[b]	Min[d]	Typ[c]	Max[d]	Unit
Reference							
Output Voltage	V_R	OSC IN = - V_{IN} (OSC Disabled), R_L = 10 MΩ	Room Full	3.92 3.85	4.0	4.08 4.15	V
Output Impedance[e]	Z_{OUT}		Room	15	30	45	kΩ
Short Circuit Current	I_{SREF}	V_{REF} = - V_{IN}	Room	70	100	130	µA
Temperature Stability[e]	T_{REF}		Full		0.25	1.0	mV/°C
Long Term Stability[e]		t = 1000 hrs., T_A = 125 °C	Room		5	25	mV
Oscillator							
Maximum Frequency[e]	f_{MAX}	R_{OSC} = 0	Room	1	3		MHz
Initial Accuracy	f_{OSC}	R_{OSC} = 330 kΩ[f]	Room	80	100	120	kHz
		R_{OSC} = 150 kΩ[f]	Room	160	200	240	
Voltage Stability	Δf/f	Δf/f = f(13.5 V) - f(10 V)/f(10 V)	Room	4	10	15	%
Temperature Coefficient[e]	T_{OSC}		Full		200	500	ppm/°C

SPECIFICATIONS[a]

Parameter	Symbol	Test Conditions Unless Otherwise Specified DISCHARGE = - V_{IN} = 0 V, V_{CC} = 10 V, + V_{IN} = 48 V, R_{BIAS} = 390 kΩ, R_{OSC} = 330 kΩ	Limits D Suffix - 40 to 85 °C Temp[b]	Min[d]	Typ[c]	Max[d]	Unit
Error Amplifier							
Feedback Input Voltage	V_{FB}	FB Tied to COMP, OSC IN = - V_{IN} (OSC Disabled)	Room	3.96	4.00	4.04	V
Input BIAS Current	I_{FB}	OSC IN = - V_{IN}, V_{FB} = 4 V	Room		25	500	nA
Input OFFSET Voltage	V_{OS}	OSC IN = - V_{IN} (OSC Disabled)	Room		± 15	± 40	mV
Open Loop Voltage Gain[e]	A_{VOL}		Room	60	80		dB
Unity Gain Bandwidth[e]	BW		Room	0.7	1		MHz
Dynamic Output Impedance[e]	Z_{OUT}		Room		1000	2000	Ω
Output Current	I_{OUT}	Source (V_{FB} = 3.4 V)	Room		- 2.0	- 1.4	mA
		Sink (V_{FB} = 4.5 V)	Room	0.12	0.15		
Power Supply Rejection	PSRR	10 V ≤ V_{CC} ≤ 13.5 V	Room	50	70		dB
Current Limit							
Threshold Voltage	V_{SOURCE}	R_L = 100 Ω from DRAIN to V_{CC}, V_{FB} = 0 V	Room	1.0	1.2	1.4	V
Delay to Output	t_d	R_L = 100 Ω from DRAIN to V_{CC}, V_{SOURCE} = 1.5 V, See Figure 1	Room		100	200	ns
Pre-Regulator/Start-Up							
Input Voltage	+ V_{IN}	I_{IN} = 10 µA	Room	120			V
Input Leakage Current	+ I_{IN}	V_{CC} ≥ 10 V	Room			10	µA
Pre-Regulator Start-Up Current	I_{START}	Pulse Width ≤ 300 µs, V_{CC} = 7 V	Room	8	15		mA
V_{CC} Pre-Regulator Turn-Off Threshold Voltage	V_{REG}	$I_{PRE-REGULATOR}$ = 10 µA	Room	7.8	9.4	9.8	V
Undervoltage Lockout	V_{UVLO}	R_L = 100 Ω from DRAIN to V_{CC}, See Detailed Description	Room	7.0	8.8	9.3	
V_{REG} - V_{UVLO}	V_{DELTA}		Room	0.3	0.6		
Supply							
Supply Current	I_{CC}		Room	0.45	0.6	1.0	mA
Bias Current	I_{BIAS}		Room	10	15	20	µA
Logic							
$\overline{\text{SHUTDOWN}}$ Delay[e]	t_{SD}	V_{SOURCE} = - V_{IN}, See Figure 2	Room		50	100	ns
$\overline{\text{SHUTDOWN}}$ Pulse Width[e]	t_{SW}	See Figure 3.	Room	50			
RESET Pulse Width[e]	t_{RW}		Room	50			
Latching Pulse Width[e] $\overline{\text{SHUTDOWN}}$ and RESET Low	t_{LW}		Room	25			
Input Low Voltage	V_{IL}		Room			2.0	V
Input High Voltage	V_{IH}		Room	8.0			
Input Current Input Voltage High	I_{IH}	V_{IN} = V_{CC}	Room		1	5	µA
Input Current Input Voltage Low	I_{IL}	V_{IN} = 0 V	Room	- 35	- 25		
MOSFET Switch							
Breakdown Voltage	$V_{BR(DSS)}$	I_{DRAIN} = 100 µA	Full	200	220		V
Drain-Source On Resistance[g]	$r_{DS(on)}$	I_{DRAIN} = 100 mA	Room		3	5	Ω
Drain Off Leakage Current	I_{DSS}	V_{DRAIN} = 150 V	Room		5	10	µA
Drain Capacitance[e]	C_{DS}		Room		35		pF

Notes:
a. Refer to PROCESS OPTION FLOWCHART for additional information.
b. Room = 25 °C, Full = as determined by the operating temperature suffix.
c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
e. Guaranteed by design, not subject to production test.
f. C_{STRAY} at OSC IN ≤ 5 pF.
g. Temperature coefficient of $r_{DS(on)}$ is 0.75 % per °C, typical.

TIMING WAVEFORMS

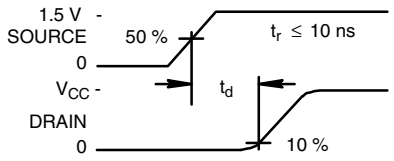


Figure 1.

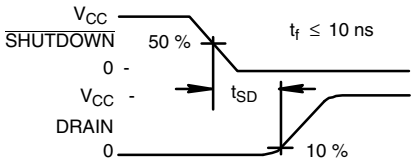


Figure 2.

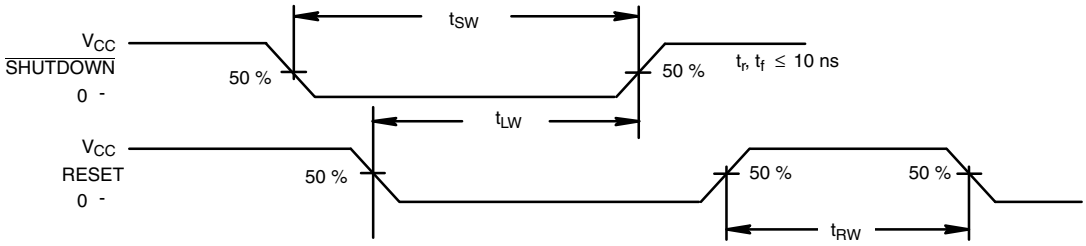


Figure 3.

TYPICAL CHARACTERISTICS

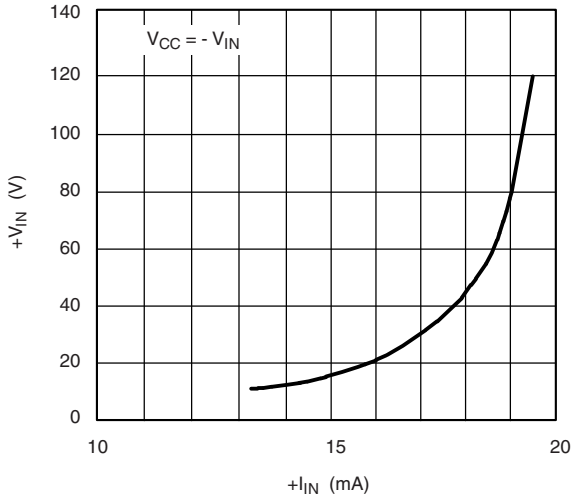


Figure 4. + V_{IN} vs. + I_{IN} at Start-Up

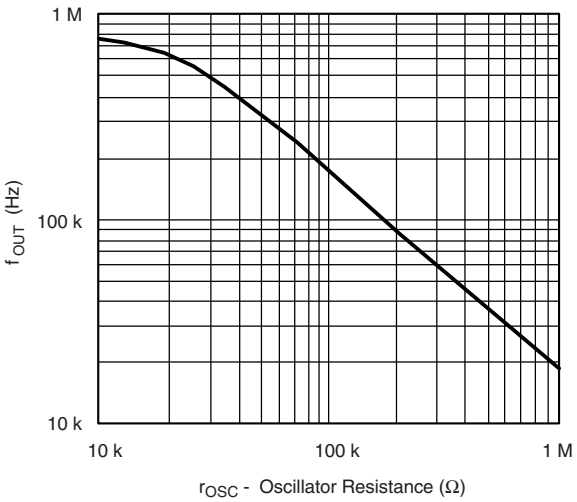
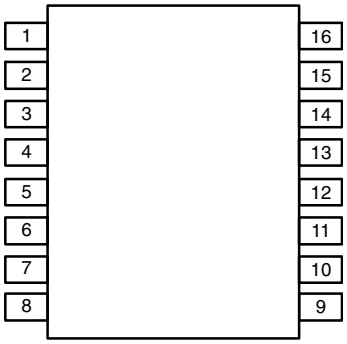


Figure 5. Output Switching Frequency vs. Oscillator Resistance

PIN CONFIGURATIONS

SO-16
(Wide-Body)



Top View

Order Number: Si9104DW

PIN DESCRIPTION

Function	Pin Number		
	14-Pin Plastic DIP	16-Pin SOIC	20-Pin PLCC
SOURCE	4	1	7
$-V_{IN}$	5	2	8
V_{CC}	6	4	9
OSC_{OUT}	7	5	10
OSC_{IN}	8	6	11
DISCHARGE	9	7	12
V_{REF}	10	8	14
$\overline{SHUTDOWN}$	11	9	16
RESET	12	10	17
COMP	13	11	18
FB	14	12	20
BIAS	1	13	2
$+V_{IN}$	2	14	3
DRAIN	3	16	5
NC		3, 15	1, 4, 6,13, 15, 19

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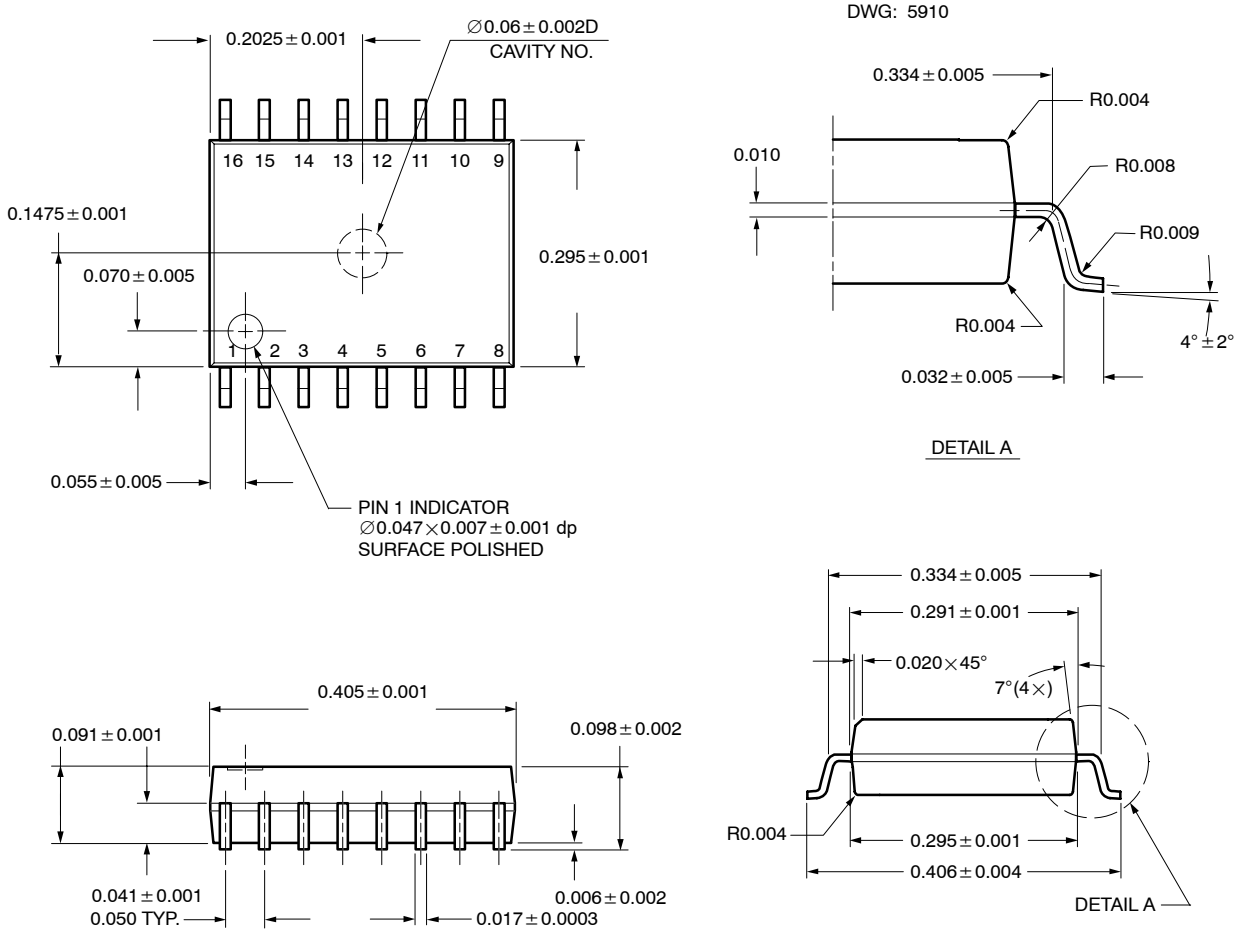
SOIC (WIDE-BODY): 16-LEAD (POWER IC ONLY)

ECN: S-40079—Rev. A, 02-Feb-04
DWG: 5910



All Dimensions In Inches

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